



# 2008 IEEE Symposium on Product Safety and Compliance Engineering



Sponsored by the IEEE Product Safety Engineering Society  
20-22 October 2008 – Austin Marriott North, Austin, TX  
[www.ieee-pses.org/symposium](http://www.ieee-pses.org/symposium)

## Call for Papers, Workshops, and Tutorials

The IEEE Product Safety Engineering Society seeks original, unpublished papers and tutorials on all aspects of product safety and compliance engineering including, but not limited to:

- Product Safety:** Consumer, medical, computer (IT), test and measurement, power supplies, telecommunication, industrial control, electric tools, home appliances, cellular and wireless, etc.
- Safety Subjects:** Electrical, mechanical, fire, thermal, chemical, optical, software, functional, reliability, etc.
- EMC / RF:** Electromagnetic emissions, electromagnetic immunity, regulatory, Introduction to EMC/RF for the safety engineer and compliance engineer.
- Components:** Grounding, insulation, opto-couplers, capacitors, transformers, current-limiters, fuses, power line filters, ferrite, environmental, electromagnetic emissions, electromagnetic immunity, regulatory, etc.
- Certification:** Product safety, electromagnetic emissions, electromagnetic immunity, environmental, processes, safety testing, regulatory, etc.
- Standards Activities:** Development, interpretations, status, interpretations, country requirements, Laboratory Accreditation, etc.
- Safety Research:** Body physiological responses to various hazardous energy sources, unique safeguard schemes, electrically-caused fire, etc.
- Environmental:** RoHS, WEEE, EuP (Energy-using Products), Energy Star, Packaging Directives, REACH (Chemical), CeC, etc.

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Elya Joffe  
Henry Benitez  
Ken Thomas

## Author's Schedule

Intent to present and topic (e-mail)	April 29, 2008
Draft e-paper	June 1, 2008
Notification of Acceptance	July 6, 2008
Complete e-paper	August 17, 2008

Send intent to present, topic, and questions to Richard Nute  
[richn@ieee.org](mailto:richn@ieee.org) or FAX 1-858-592-2620

See <http://www.ieee-pses.org/symposium/index.html#CFP>  
for more details on requirements and dates.